



Practitioner's Docket No. 56386 (71987)

PATENT

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Ltr to Drafts
J. McMillan
1/8/03

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

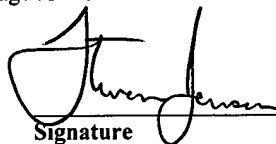
In re application of: C. Wu et al.
Serial No.: 09/932,053 Group No.: 2823
Filed: August 18, 2001 Examiner: H. Lee
For: SEMICONDUCTOR PACKAGE AND FABRICATING METHOD THEREOF

Assistant Commissioner for Patents
Washington, D.C. 20231

CERTIFICATE OF MAILING (37 C.F.R. 1.8(a))

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Date: November 22, 2002

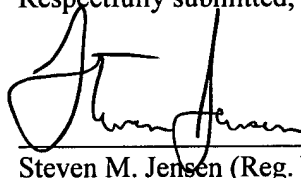

Signature

Steven M. Jensen
(type or print name of person mailing paper)

LETTER TO OFFICIAL DRAFTSMAN

Enclosed are marked-up versions of FIGS. 3, 4A, 4B, 4D, and 4E. Reference numerals and lead lines have been corrected. Approval of the drawing corrections is respectfully requested.

Respectfully submitted,



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